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REVISION HISTORY

7/05—Revision 0: Initial Version

SPECIFICATIONS

$V_S = 5\text{ V}$, @ $T_A = 25^\circ\text{C}$, $V_O = 1.4\text{ V p-p}$, $G = \times 2$, $R_L = 150\ \Omega$, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
OVERALL PERFORMANCE					
Offset Error	Input referred, all channels		12	30	mV
Offset Adjust Range	Input referred		± 500		mV
Input Voltage Range, All Inputs		$V_{S-} - 0.1$		$V_{S+} - 2.0$	V
Output Voltage Swing, All Outputs	Positive swing	$V_{S+} - 0.33$	$V_{S+} - 0.22$		V
	Negative swing		$V_{S-} + 0.10$	$V_{S-} + 0.13$	V
Linear Output Current per Channel			30		mA
Integrated Voltage Noise, Referred to Input	All channels		0.52		mV rms
Filter Input Bias Current	All channels		6.6		μA
Total Harmonic Distortion at 1 MHz	$F_C = 36\text{ MHz}$, $F_C = 18\text{ MHz}/F_C = 9\text{ MHz}$		0.01/0.04		%
Gain Error Magnitude	$G = \times 2/G = \times 4$		0.13/0.15	0.38/0.40	dB
FILTER DYNAMIC PERFORMANCE					
-1 dB Bandwidth	Cutoff frequency select = 36 MHz	26.5	30.5		MHz
	Cutoff frequency select = 18 MHz	13.5	15.5		MHz
	Cutoff frequency select = 9 MHz	6.5	7.8		MHz
-3 dB Bandwidth	Cutoff frequency select = 36 MHz	34	37		MHz
	Cutoff frequency select = 18 MHz	16	18		MHz
	Cutoff frequency select = 9 MHz	8	9		MHz
Out-of-Band Rejection	$f = 75\text{ MHz}$	-31	-43		dB
Crosstalk	$f = 5\text{ MHz}$, $F_C = 36\text{ MHz}$		-62		dB
Input Mux Isolation	$f = 1\text{ MHz}$, $R_{SOURCE} = 300\ \Omega$		91		dB
Propagation Delay	$f = 5\text{ MHz}$, $F_C = 36\text{ MHz}$		20		ns
Group Delay Variation	Cutoff frequency select = 36 MHz		7		ns
	Cutoff frequency select = 18 MHz		11		ns
	Cutoff frequency select = 9 MHz		24		ns
Differential Gain	NTSC, $F_C = 9\text{ MHz}$		0.16		%
Differential Phase	NTSC, $F_C = 9\text{ MHz}$		0.05		Degrees
CONTROL INPUT PERFORMANCE					
Input Logic 0 Voltage	All inputs except DISABLE			0.8	V
Input Logic 1 Voltage	All inputs except DISABLE	2.0			V
Input Bias Current	All inputs except DISABLE		10	15	μA
DISABLE PERFORMANCE					
DISABLE Assert Voltage			$V_{S+} - 0.5$		V
DISABLE Assert Time			100		ns
DISABLE Deassert Time			130		ns
DISABLE Input Bias Current			10	15	μA
Input-to-Output Isolation—Disabled	$f = 10\text{ MHz}$		90		dB
POWER SUPPLY					
Operating Range		4.5		12	V
Quiescent Current			53	56	mA
Quiescent Current—Disabled			15	150	μA
PSRR, Positive Supply	All channels	62	70		dB
PSRR, Negative Supply	All channels	57	65		dB

ADA4411-3

$V_S = \pm 5\text{ V}$, @ $T_A = 25^\circ\text{C}$, $V_O = 1.4\text{ V p-p}$, $G = \times 2$, $R_L = 150\ \Omega$, unless otherwise noted.

Table 2.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
OVERALL PERFORMANCE					
Offset Error	Input referred, all channels		13	32	mV
Offset Adjust Range	Input referred		± 500		mV
Input Voltage Range, All Inputs		$V_{S-} - 0.1$		$V_{S+} - 2.0$	V
Output Voltage Swing, All Outputs	Positive swing	$V_{S+} - 0.42$	$V_{S+} - 0.24$		V
	Negative swing		$V_{S-} + 0.24$	$V_{S-} + 0.42$	V
Linear Output Current per Channel			30		mA
Integrated Voltage Noise, Referred to Input	All channels		0.50		mV rms
Filter Input Bias Current	All channels		6.3		μA
Total Harmonic Distortion at 1 MHz	$F_C = 36\text{ MHz}$, $F_C = 18\text{ MHz}$ / $F_C = 9\text{ MHz}$		0.01/0.03		%
Gain Error Magnitude	$G = \times 2/G = \times 4$		0.13/0.13	0.34/0.36	dB
FILTER DYNAMIC PERFORMANCE					
-1 dB Bandwidth	Cutoff frequency select = 36 MHz		30.0		MHz
	Cutoff frequency select = 18 MHz		15.0		MHz
	Cutoff frequency select = 9 MHz		7.8		MHz
-3 dB Bandwidth	Cutoff frequency select = 36 MHz	33	36		MHz
	Cutoff frequency select = 18 MHz	17	18		MHz
	Cutoff frequency select = 9 MHz	8	9		MHz
Out-of-Band Rejection	$f = 75\text{ MHz}$	-31	-42		dB
Crosstalk	$f = 5\text{ MHz}$, $F_C = 36\text{ MHz}$		-62		dB
Input MUX Isolation	$f = 1\text{ MHz}$, $R_{\text{SOURCE}} = 300\ \Omega$		91		dB
Propagation Delay	$f = 5\text{ MHz}$, $F_C = 36\text{ MHz}$		19	25	ns
Group Delay Variation	Cutoff frequency select = 36 MHz		7		ns
	Cutoff frequency select = 18 MHz		13		ns
	Cutoff frequency select = 9 MHz		22		ns
Differential Gain	NTSC, $F_C = 9\text{ MHz}$		0.04		%
Differential Phase	NTSC, $F_C = 9\text{ MHz}$		0.16		Degrees
CONTROL INPUT PERFORMANCE					
Input Logic 0 Voltage	All inputs except DISABLE			0.8	V
Input Logic 1 Voltage	All inputs except DISABLE	2.0			V
Input Bias Current	All inputs except DISABLE		10	15	μA
DISABLE PERFORMANCE					
DISABLE Assert Voltage			$V_{S+} - 0.5$		V
DISABLE Assert Time			75		ns
DISABLE Deassert Time			125		ns
DISABLE Input Bias Current			34	45	μA
Input-to-Output Isolation—Disabled	$f = 10\text{ MHz}$		90		dB
POWER SUPPLY					
Operating Range		4.5		12	V
Quiescent Current			57	60	mA
Quiescent Current—Disabled			15	150	μA
PSRR, Positive Supply	All channels	64	74		dB
PSRR, Negative Supply	All channels	57	65		dB

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	12 V
Power Dissipation	See Figure 2
Storage Temperature	–65°C to +125°C
Operating Temperature Range	–40°C to +85°C
Lead Temperature Range (Soldering 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, θ_{JA} is specified for device soldered in circuit board for surface-mount packages.

Table 4. Thermal Resistance

Package Type	θ_{JA}	Unit
24 Lead QSOP	83	°C/W

Maximum Power Dissipation

The maximum safe power dissipation in the ADA4411-3 package is limited by the associated rise in junction temperature (T_J) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit may change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4411-3. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices potentially causing failure.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power is the voltage between the supply pins (V_S) times the quiescent current (I_S). The power dissipated due to load drive depends on the particular application. For each output, the power due to load drive is calculated by multiplying the load current by the associated voltage drop across the device. The power dissipated due to all of the loads is equal to the sum of the power dissipations due to each individual load. RMS voltages and currents must be used in these calculations.

Airflow increases heat dissipation, effectively reducing θ_{JA} . In addition, more metal directly in contact with the package leads from metal traces, through-holes, ground, and power planes reduces the θ_{JA} .

Figure 2 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 24-lead QSOP (83°C/W) on a JEDEC standard 4-layer board. θ_{JA} values are approximations.

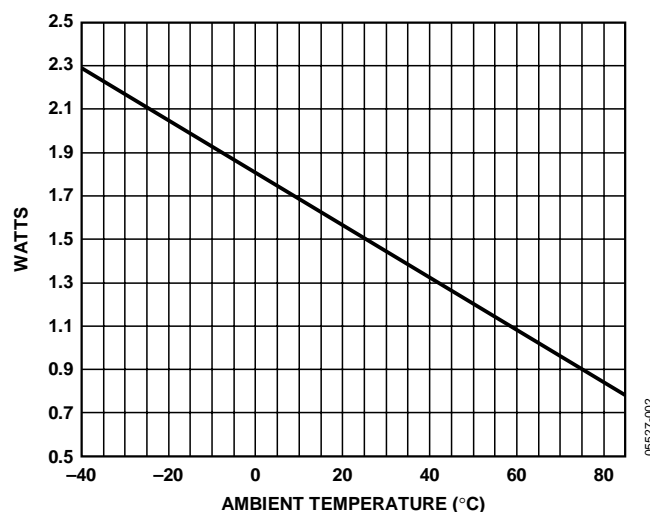


Figure 2. Maximum Power Dissipation vs. Temperature for a 4-Layer Board

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

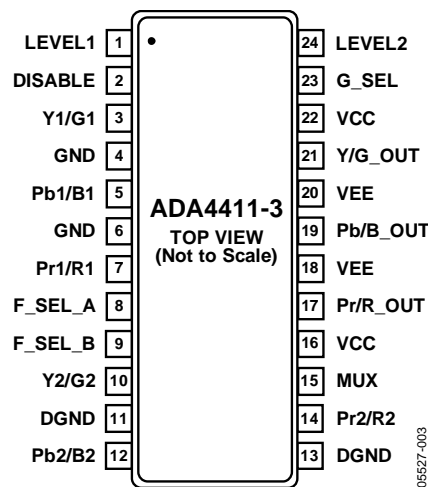


Figure 3. 24-Lead QSOP Pin Configuration

Table 5. 24-Lead QSOP Pin Function Descriptions

Pin No.	Name	Description
1	LEVEL1	DC Level Adjust Pin 1
2	DISABLE	Disable/Power Down
3	Y1/G1	Channel 1 Y/G Video Input
4	GND	Signal Ground Reference
5	Pb1/B1	Channel 1 Pb/B Video Input
6	GND	Signal Ground Reference
7	Pr1/R1	Channel 1 Pr/R Video Input
8	F_SEL_A	Filter Cutoff Select Input A
9	F_SEL_B	Filter Cutoff Select Input B
10	Y2/G2	Channel 2 Y/G Video Input
11	DGND	Digital Ground Reference
12	Pb2/B2	Channel 2 Pb/B Video Input
13	DGND	Digital Ground Reference
14	Pr2/R2	Channel 2 Pr/R Video Input
15	MUX	Input Mux Select Line
16	VCC	Positive Power Supply
17	Pr/R_OUT	Pr/R Video Output
18	VEE	Negative Power Supply
19	Pb/B_OUT	Pb/B Video Output
20	VEE	Negative Power Supply
21	Y/G_OUT	Y/G Video Output
22	VCC	Positive Power Supply
23	G_SEL	Gain Select
24	LEVEL2	DC Level Adjust Pin 2

TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise noted, $G = \times 2$, $R_L = 150\ \Omega$, $V_O = 1.4\ \text{V p-p}$, $V_S = 5\ \text{V}$, $T_A = 25^\circ\text{C}$.

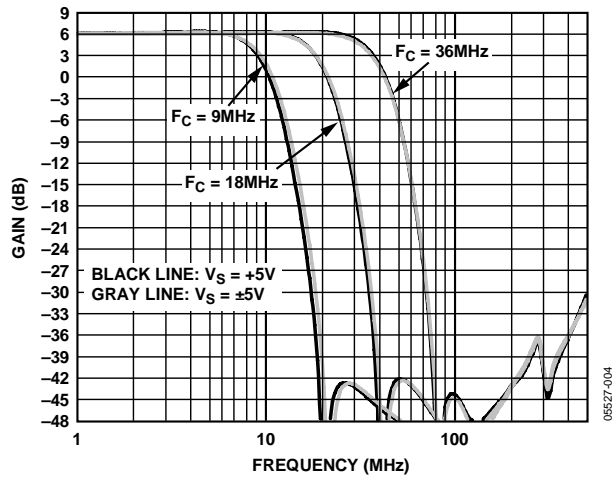


Figure 4. Frequency Response vs. Power Supply and Cutoff Frequency ($G = \times 2$)

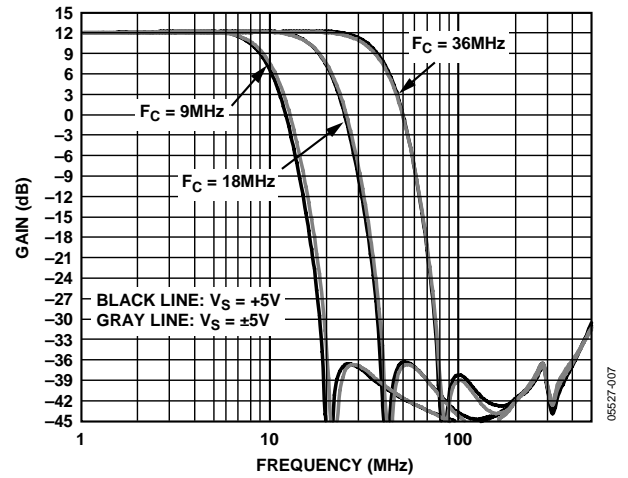


Figure 7. Frequency Response vs. Power Supply and Cutoff Frequency ($G = \times 4$)

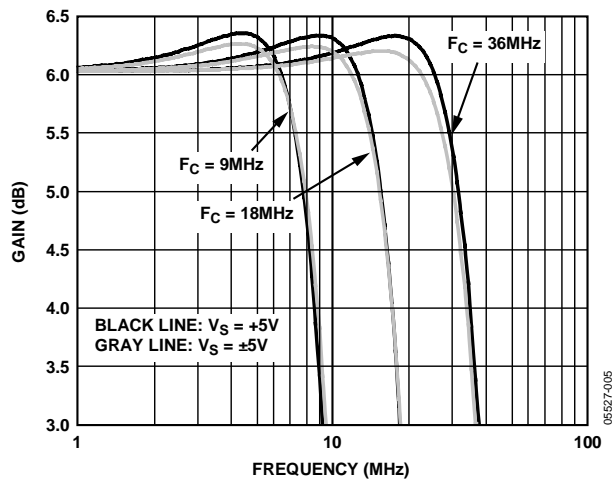


Figure 5. Frequency Response Flatness vs. Power Supply and Cutoff Frequency ($G = \times 2$)

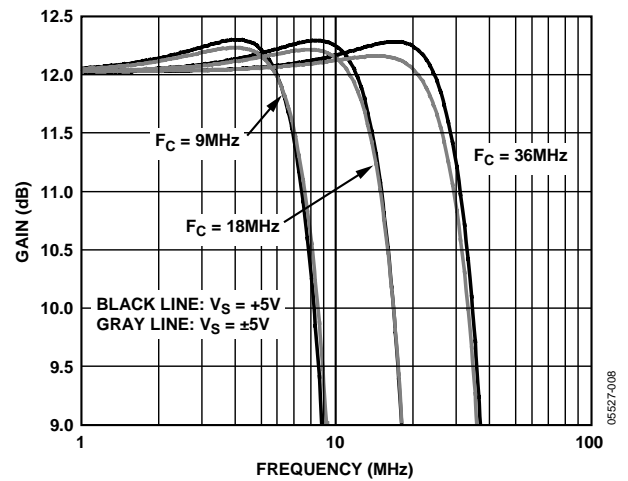


Figure 8. Frequency Response Flatness vs. Power Supply and Cutoff Frequency ($G = \times 4$)

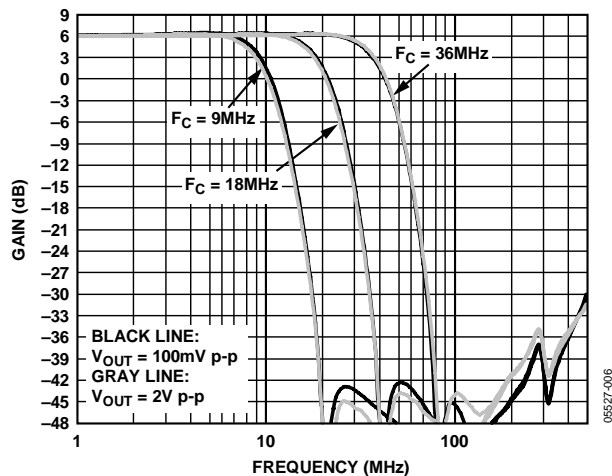


Figure 6. Frequency Response vs. Cutoff Frequency and Output Amplitude

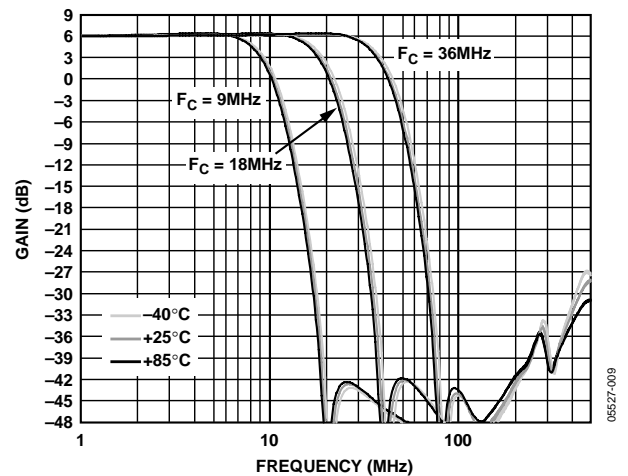


Figure 9. Frequency Response vs. Temperature and Cutoff Frequency

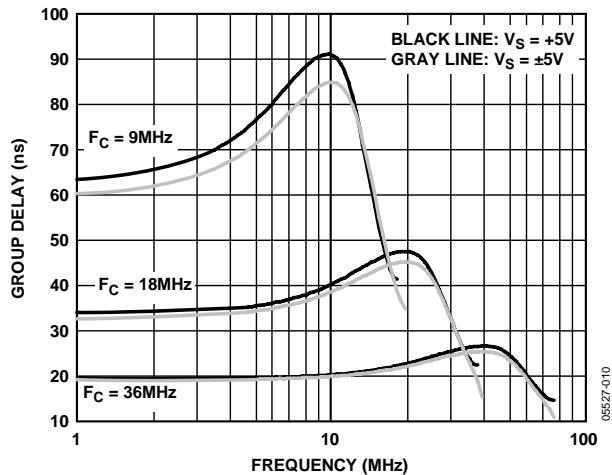


Figure 10. Group Delay vs. Frequency, Power Supply, and Cutoff Frequency

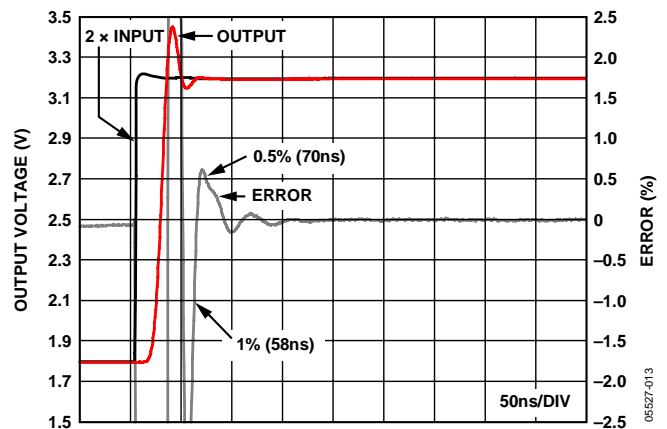


Figure 13. Settling Time

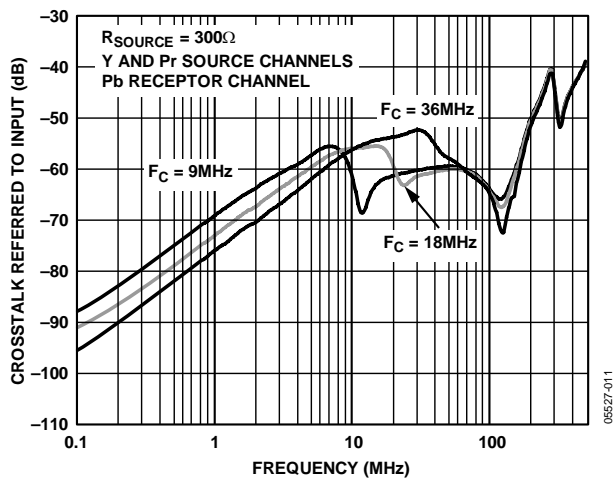


Figure 11. Channel-to-Channel Crosstalk vs. Frequency and Cutoff Frequency

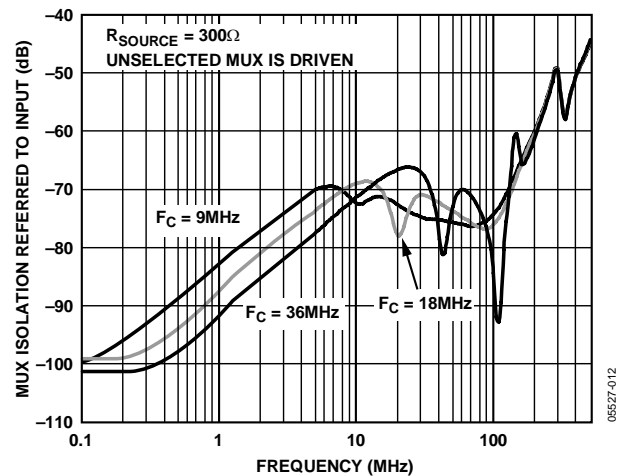


Figure 14. MUX Isolation vs. Frequency and Cutoff Frequency

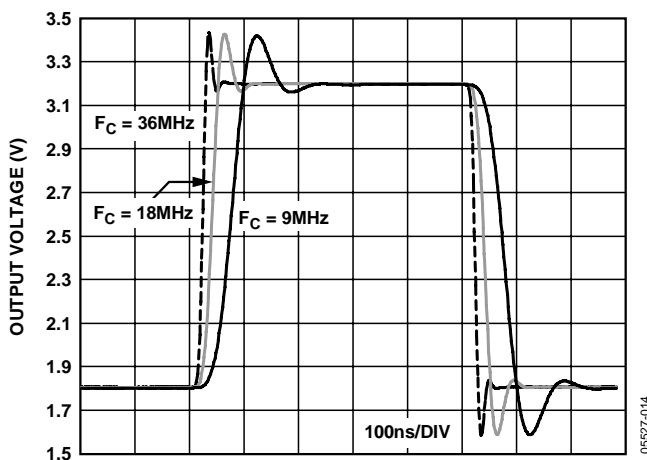


Figure 12. Transient Response vs. Cutoff Frequency ($G = \times 2$)

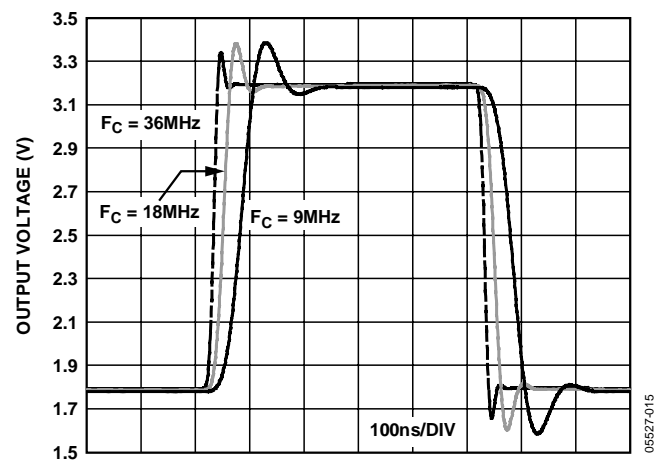


Figure 15. Transient Response vs. Cutoff Frequency ($G = \times 4$)

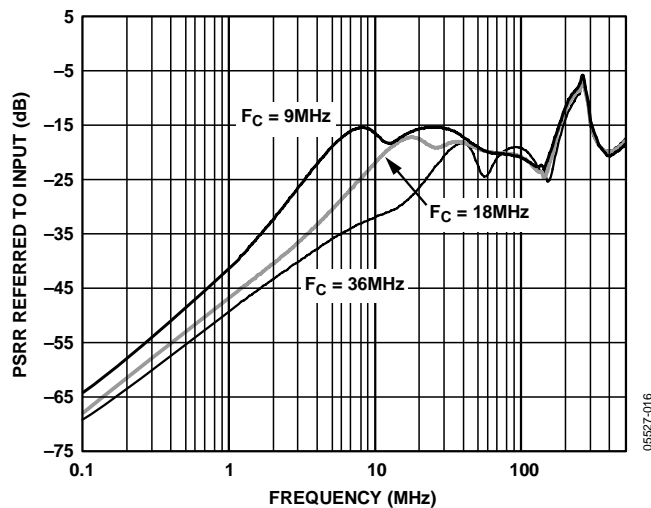


Figure 16. Positive Supply PSRR vs. Frequency and Cutoff Frequency

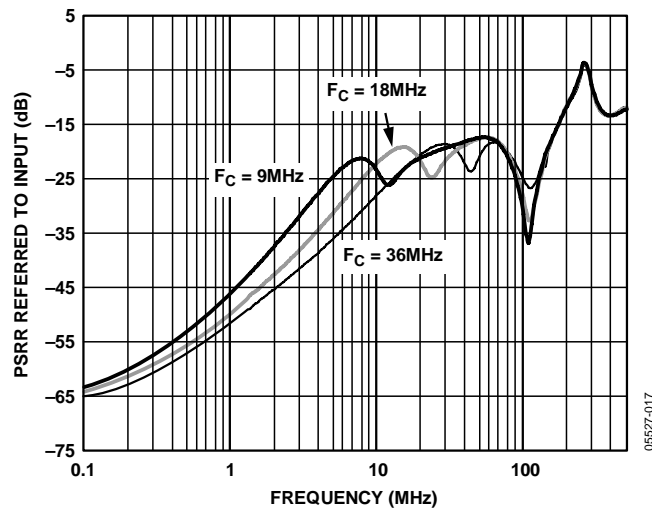


Figure 18. Negative Supply PSRR vs. Frequency and Cutoff Frequency

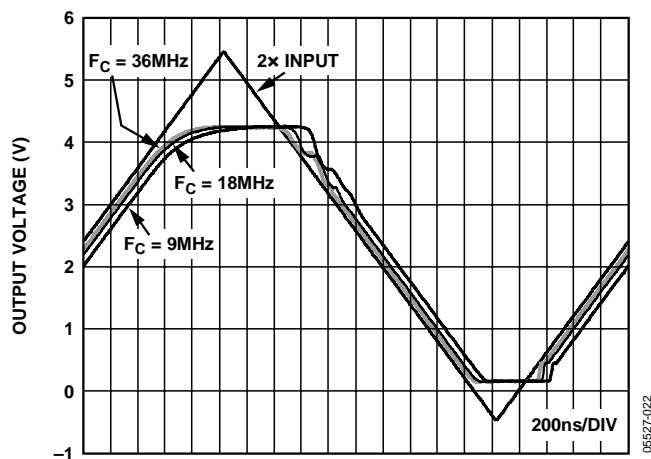


Figure 17. Overdrive Recovery vs. Cutoff Frequency

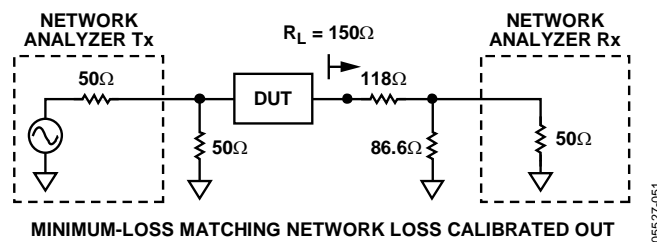


Figure 19. Basic Test Circuit for Swept Frequency Measurements

THEORY OF OPERATION

The ADA4411-3 is an integrated video filtering and driving solution that offers variable bandwidth to meet the needs of a number of different video resolutions. There are three filters, targeted for use with component video signals. The filters have selectable bandwidths that correspond to the popular component video standards. Each filter has a sixth-order Butterworth response that includes group delay optimization. The group delay variation from 1 MHz to 36 MHz in the 36 MHz section is 7 ns, which produces a fast settling pulse response.

The ADA4411-3 is designed to operate in many video environments. The supply range is 5 V to 12 V, single supply or dual supply, and requires a relatively low nominal quiescent current of 15 mA per channel. In single-supply applications, the PSRR is greater than 60 dB, providing excellent rejection in systems with supplies that are noisy or under-regulated. In applications where power consumption is critical, the part can be powered down to draw typically 15 μ A by pulling the DISABLE pin to the most positive rail. The ADA4411-3 is also well-suited for high encoding frequency applications because it maintains a stop-band attenuation of more than 40 dB to 400 MHz.

The ADA4411-3 is intended to take dc-coupled inputs from an encoder or other ground referenced video signals. The ADA4411-3 input is high impedance. No minimum or maximum input termination is required, though input terminations above 1 k Ω can degrade crosstalk performance at high frequencies. No clamping is provided internally. For applications where dc restoration is required, dual supplies work best. Using a termination resistance of less than a few hundred ohms to ground on the inputs and suitably adjusting the level-shifting circuitry provides precise placement of the output voltage.

For single-supply applications ($V_{S-} = \text{GND}$), the input voltage range extends from 100 mV below ground to within 2.0 V of the most positive supply. Each filter section has a 2:1 input multiplexer that includes level-shifting circuitry. The level-shifting circuitry adds a dc component to ground-referenced input signals so that they can be reproduced accurately without the output buffers hitting the negative rail. Because the filters have negative rail input and rail-to-rail output, dc level shifting is generally not necessary, unless accuracy greater than that of the saturated output of the driver is required at the most negative edge. This varies with load but is typically 100 mV in a dc-coupled, single-supply application. If ac coupling is used, the saturated output level is higher because the drivers have to sink more current on the low side. If dual supplies are used ($V_{S-} < \text{GND}$), no level shifting is required. In dual-supply applications, the level-shifting circuitry can be used to take a ground referenced signal and put the blanking level at ground while the sync level is below ground.

The output drivers on the ADA4411-3 have rail-to-rail output capabilities. They provide either 6 dB or 12 dB of gain with respect to the ground pins. Gain is controlled by the external gain select pin. Each output is capable of driving two ac- or dc-coupled 75 Ω source-terminated loads. If a large dc output level is required while driving two loads, ac coupling should be used to limit the power dissipation.

Input MUX isolation is primarily a function of the source resistance driving into the ADA4411-3. Higher resistances result in lower isolation over frequency, while a low source resistance, such as 75 Ω , has the best isolation performance. See Figure 14 for the MUX isolation performance.

APPLICATIONS

OVERVIEW

With its high impedance multiplexed inputs and high output drive, the ADA4411-3 is ideally suited to video reconstruction and antialias filtering applications. The high impedance inputs give designers flexibility with regard to how the input signals are terminated. Devices with DAC current source outputs that feed the ADA4411-3 can be loaded in whatever resistance provides the best performance, and devices with voltage outputs can be optimally terminated as well. The ADA4411-3 outputs can each drive up to two source-terminated 75 Ω loads and can therefore directly drive the outputs from set-top boxes, DVD players, and the like without the need for a separate output buffer.

Binary control inputs are provided to select cutoff frequency, throughput gain, and input signal. These inputs are compatible with 3 V and 5 V TTL and CMOS logic levels referenced to GND. The disable feature is asserted by pulling the DISABLE pin to the positive supply.

The LEVEL1 and LEVEL2 inputs comprise a differential input that controls the dc level at the output pins.

MULTIPLEXER SELECT INPUTS

Selection between the two multiplexer inputs is controlled by the logic signals applied to the MUX inputs. Table 6 summarizes the multiplexer operation.

THROUGHPUT GAIN

The throughput gain of the ADA4411-3 signal paths can be either $\times 2$ or $\times 4$. Gain selection is controlled by the logic signal applied to the G_SEL pin. Table 6 summarizes how the gain is selected.

DISABLE

The ADA4411-3 includes a disable feature that can be used to save power when a particular device is not in use. As indicated in the Overview section, the disable feature is asserted by pulling the DISABLE pin to the positive supply. Table 6 summarizes the disable feature operation. The DISABLE pin also functions as a reference level for the logic inputs and therefore must be connected to ground when the device is not disabled.

Table 6. Logic Pin Function Description

DISABLE	MUX	G_SEL
V _{S+} = Disabled	1 = Channel 1 Selected	1 = $\times 2$ Gain
GND = Enabled	0 = Channel 2 Selected	0 = $\times 4$ Gain

CUTOFF FREQUENCY SELECTION

Four combinations of cutoff frequencies are provided for the video signals. The cutoff frequencies have been selected to correspond with the most commonly deployed component video scanning systems. Selection between the cutoff frequency combinations is controlled by the logic signals applied to the F_SEL_A and F_SEL_B inputs. Table 7 summarizes cutoff frequency selection.

Table 7. Filter Cutoff Frequency Selection

F_SEL_A	F_SEL_B	Y/G Cutoff	Pb/B Cutoff	Pr/R Cutoff
0	0	36 MHz	36 MHz	36 MHz
0	1	36 MHz	18 MHz	18 MHz
1	0	18 MHz	18 MHz	18 MHz
1	1	9 MHz	9 MHz	9 MHz

OUTPUT DC OFFSET CONTROL

The LEVEL1 and LEVEL2 inputs work as a differential, input-referred output offset control. In other words, the output offset voltage of a given channel is equal to the difference in voltage between the LEVEL1 and LEVEL2 inputs, multiplied by the overall filter gain. This relationship is expressed in Equation 1.

$$V_{OS}(OUT) = (LEVEL1 - LEVEL2)(G) \quad (1)$$

LEVEL1 and LEVEL2 are the voltages applied to the respective inputs, and G is the throughput gain.

For example, with the G_SEL input set for $\times 2$ gain, setting LEVEL1 to 300 mV and LEVEL2 to 0 V shifts the offset voltages at the ADA4411-3 outputs to 600 mV. This particular setting can be used in most single-supply applications to keep the output swings safely above the negative supply rail.

The maximum differential voltage that can be applied across the LEVEL1 and LEVEL2 inputs is ± 500 mV. From a single-ended standpoint, the LEVEL1 and LEVEL2 inputs have the same range as the filter inputs. See the Specifications tables for the limits. The LEVEL1 and LEVEL2 inputs must each be bypassed to GND with a 0.1 μ F ceramic capacitor.

In single-supply applications, a positive output offset must be applied to keep the negative-most excursions of the output signals above the specified minimum output swing limit.

Figure 20 and Figure 21 illustrate several ways to use the LEVEL1 and LEVEL2 inputs. Figure 20 shows examples of how to generate fully adjustable LEVEL1 and LEVEL2 voltages from ± 5 V and single +5 V supplies. These circuits show a general case, but a more practical approach is to fix one voltage and vary the other. Figure 21 illustrates an effective way to produce a 600 mV output offset voltage in a single-supply application. Although the LEVEL2 input could simply be connected to GND, Figure 21 includes bypassed resistive voltage dividers for each input so that the input levels can be changed, if necessary. Additionally, many in-circuit testers require that I/O signals not be tied directly to the supplies or GND. DNP indicates do not populate.

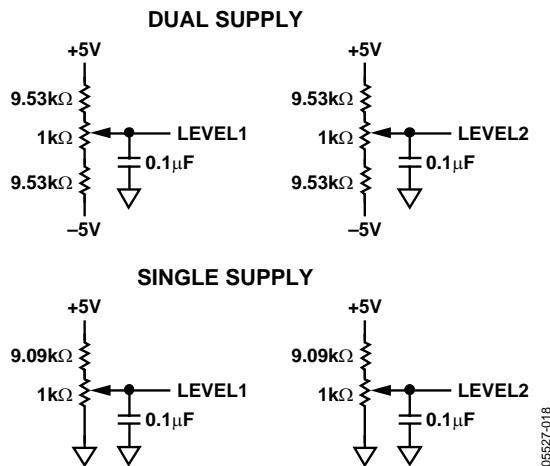


Figure 20. Generating Fully Adjustable Output Offsets

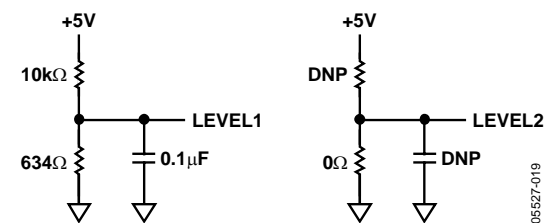


Figure 21. Flexible Circuits to Set the LEVEL1 and LEVEL2 Inputs to Obtain a 600 mV Output Offset on a Single Supply

INPUT AND OUTPUT COUPLING

Inputs to the ADA4411-3 are normally dc-coupled. Ac coupling the inputs is not recommended; however, if ac coupling is necessary, suitable circuitry must be provided following the ac coupling element to provide proper dc level and bias currents at the ADA4411-3 input stages. The ADA4411-3 outputs can be either ac- or dc-coupled.

When driving single ac-coupled loads in standard 75 Ω video distribution systems, 220 μ F coupling capacitors are recommended for use on all but the chrominance signal output. Since the chrominance signal is a narrow-band modulated carrier, it has no low frequency content and can therefore be coupled with a 0.1 μ F capacitor.

There are two ac coupling options when driving two loads from one output. One simply uses the same value capacitor on the second load, while the other is to use a common coupling capacitor that is at least twice the value used for the single load (see Figure 22 and Figure 23).

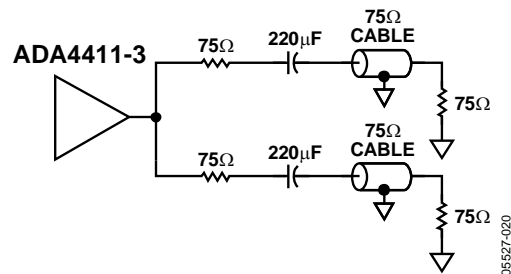


Figure 22. Driving Two AC-Coupled Loads with Two Coupling Capacitors

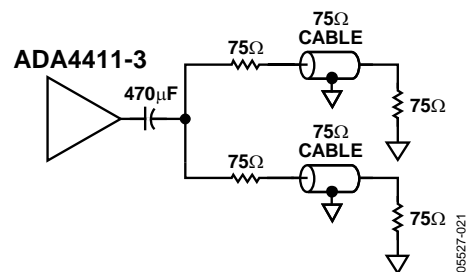


Figure 23. Driving Two AC-Coupled Loads with One Common Coupling Capacitor

When driving two parallel 150 Ω loads (75 Ω effective load), the 3 dB bandwidth of the filters typically varies from that of the filters with a single 150 Ω load. For the 9 MHz and 18 MHz filters, the typical variation is within $\pm 1.0\%$; for the 36 MHz filters, the typical variation is within $\pm 2.5\%$.

PRINTED CIRCUIT BOARD LAYOUT

As with all high speed applications, attention to printed circuit board layout is of paramount importance. Standard high speed layout practices should be adhered to when designing with the ADA4411-3. A solid ground plane is recommended, and surface-mount, ceramic power supply decoupling capacitors should be placed as close as possible to the supply pins. All of the ADA4411-3 GND pins should be connected to the ground plane with traces that are as short as possible. Controlled impedance traces of the shortest length possible should be used to connect to the signal I/O pins and should not pass over any voids in the ground plane. A $75\ \Omega$ impedance level is typically used in video applications. All signal outputs of the ADA4411-3 should include series termination resistors when driving transmission lines.

When the ADA4411-3 receives its inputs from a device with current outputs, the required load resistor value for the output current is often different from the characteristic impedance of the signal traces. In this case, if the interconnections are sufficiently short ($\ll 0.1$ wavelength), the trace does not have to be terminated in its characteristic impedance. Traces of $75\ \Omega$ can be used in this instance, provided their lengths are an inch or two at the most. This is easily achieved because the ADA4411-3 and the device feeding it are usually adjacent to each other, and connections can be made that are less than one inch in length.

VIDEO ENCODER RECONSTRUCTION FILTER

The ADA4411-3 is easily applied as a reconstruction filter at the DAC outputs of a video encoder. Figure 24 illustrates how to use the ADA4411-3 in this type of application with an ADV7322 video encoder in a single-supply application with ac-coupled outputs.

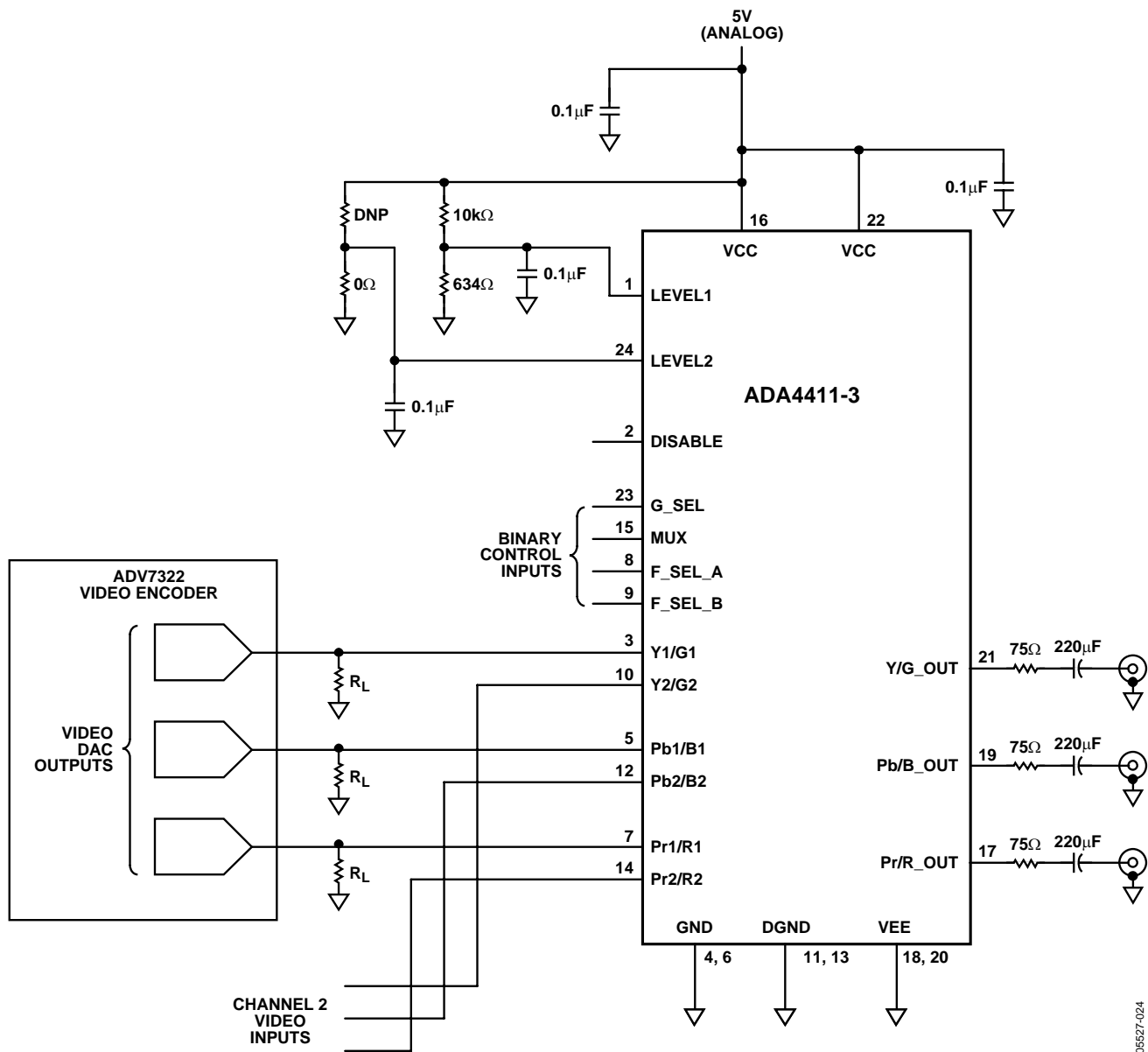
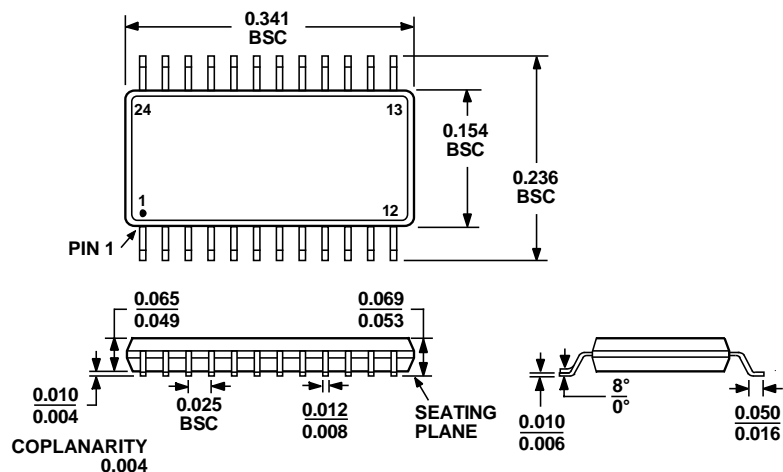


Figure 24. The ADA4411-3 Applied as a Single-Supply Reconstruction Filter Following the ADV7322

05527-024

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-137AE

Figure 25. 24-Lead Shrink Small Outline Package [QSOP]
(RQ-24)

Dimensions shown in inches

ORDERING GUIDE

Model	Temperature Range	Package Description	Order Quantity	Package Option
ADA4411-3ARQZ ¹	–40°C to +85°C	24-Lead QSOP	1	RQ-24
ADA4411-3ARQZ-R7 ¹	–40°C to +85°C	24-Lead QSOP	1,000	RQ-24
ADA4411-3ARQZ-RL ¹	–40°C to +85°C	24-Lead QSOP	2,500	RQ-24

¹ Z = Pb-free part.

ADA4411-3

NOTES